



Material Content Data Sheet



Sales Product Name				IGP10N60T		Issued		1. August 2018	
MA#				MA001707658					
Package				PG-TO220-3-1		Weight*		2029.52 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	1.169	0.06	0.06	576	576	
leadframe	inorganic material	phosphorus	7723-14-0	0.245	0.01		121		
	non noble metal	iron	7439-89-6	0.816	0.04		402		
	non noble metal	copper	7440-50-8	815.335	40.19	40.24	401736	402259	
	non noble metal	aluminium	7429-90-5	1.614	0.08	0.08	795	795	
wire	non noble metal	aluminium	7429-90-5	1.614	0.08	0.08	795	795	
encapsulation	organic material	carbon black	1333-86-4	5.975	0.29		2944		
	plastics	epoxy resin	-	113.520	5.59		55934		
	inorganic material	silicondioxide	60676-86-0	477.978	23.55	29.43	235513	294391	
leadfinish	non noble metal	tin	7440-31-5	21.462	1.06	1.06	10575	10575	
plating	inorganic material	phosphorus	7723-14-0	0.001	0.00		1		
	non noble metal	nickel	7440-02-0	0.244	0.01	0.01	120	121	
solder	non noble metal	antimony	7440-36-0	0.093	0.00		46		
	noble metal	silver	7440-22-4	0.233	0.01		115		
	non noble metal	tin	7440-31-5	0.605	0.03	0.04	298	459	
heatspreader	inorganic material	phosphorus	7723-14-0	0.177	0.01		87		
	non noble metal	iron	7439-89-6	0.590	0.03		291		
	non noble metal	copper	7440-50-8	589.466	29.04	29.08	290446	290824	
*deviation	< 10%			Sum in total:		100.00		1000000	

Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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